

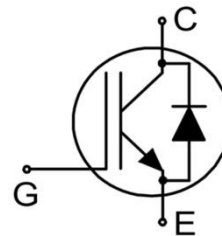
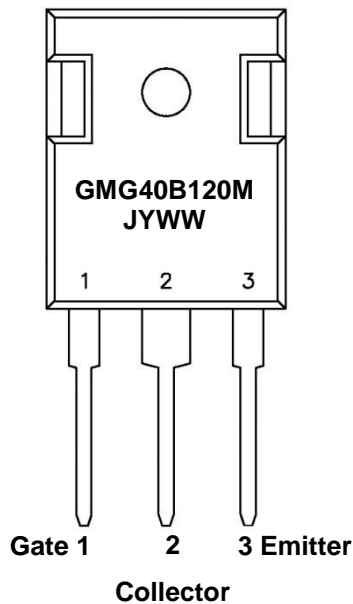
## Features

- ◆ Trench Field Stop technology
- ◆ Fast Switching Characteristics
- ◆ Low Turnoff Voltage Spike
- ◆ Ultrafast Recovery Diodo embedded
- ◆ Low Forward Voltage
- ◆ Low Leakage Current

## Applications

- ◆ Uninterruptable Power System, UPS
- ◆ General Purpose Frequency Conversion

## Marking Information and Pin Assignment – TO-247 (Top View)



J: Assembly / Test Site Code  
Y: Year  
WW: Week

## Order Information

Ordering Number	Package	Shipping
GMG40B120MTD3T	TO-247	50 Units/Tube. 40 Tubes/Box, 4 Boxes/Carton

## Absolute Maximum Ratings (Note 1)

SYMBOL	PARAMETER		RATINGS	UNITS
$V_{CES}$	Collector to Emitter Voltage		1200	V
$I_C$	Collector Current	$T_C = 25^{\circ}\text{C}$	80	A
		$T_C = 100^{\circ}\text{C}$	40	
$I_{CP}$ (Note 2)	Collector Pulse Current		160	A
$I_{RBSOA}$ (Note 2)	RBSOA Current $V_{CE} \leq 600\text{V}$ , $T_J \leq 150^{\circ}\text{C}$ , $t_p = 1\mu\text{s}$		160	A
$I_F$	Diode Forward Current	$T_C = 25^{\circ}\text{C}$	80	A
		$T_C = 100^{\circ}\text{C}$	40	
$I_{CF}$ (Note 2)	Diode Pulse Current		160	A
$t_{SC}$	Short Circuit Withstand Duration, $V_{GE}=15\text{V}$ , $V_{CC}=400\text{V}$ , $T_J \leq 150^{\circ}\text{C}$		10	$\mu\text{s}$
$V_{GE}$	Gate-Emmitter Voltage		$\pm 20$	V
$P_{TOT}$	Power dissipation,	$T_C = 25^{\circ}\text{C}$	277	W
		$T_C = 100^{\circ}\text{C}$	111	
$T_J$	Maximum IGBT Junction Temperature		$-55 \sim 150$	$^{\circ}\text{C}$
$T_{stg}$	Storage Temperature Range		$-55 \sim 150$	$^{\circ}\text{C}$

Note 1 Compliance to JESD-022

Note 2 Simulated Results

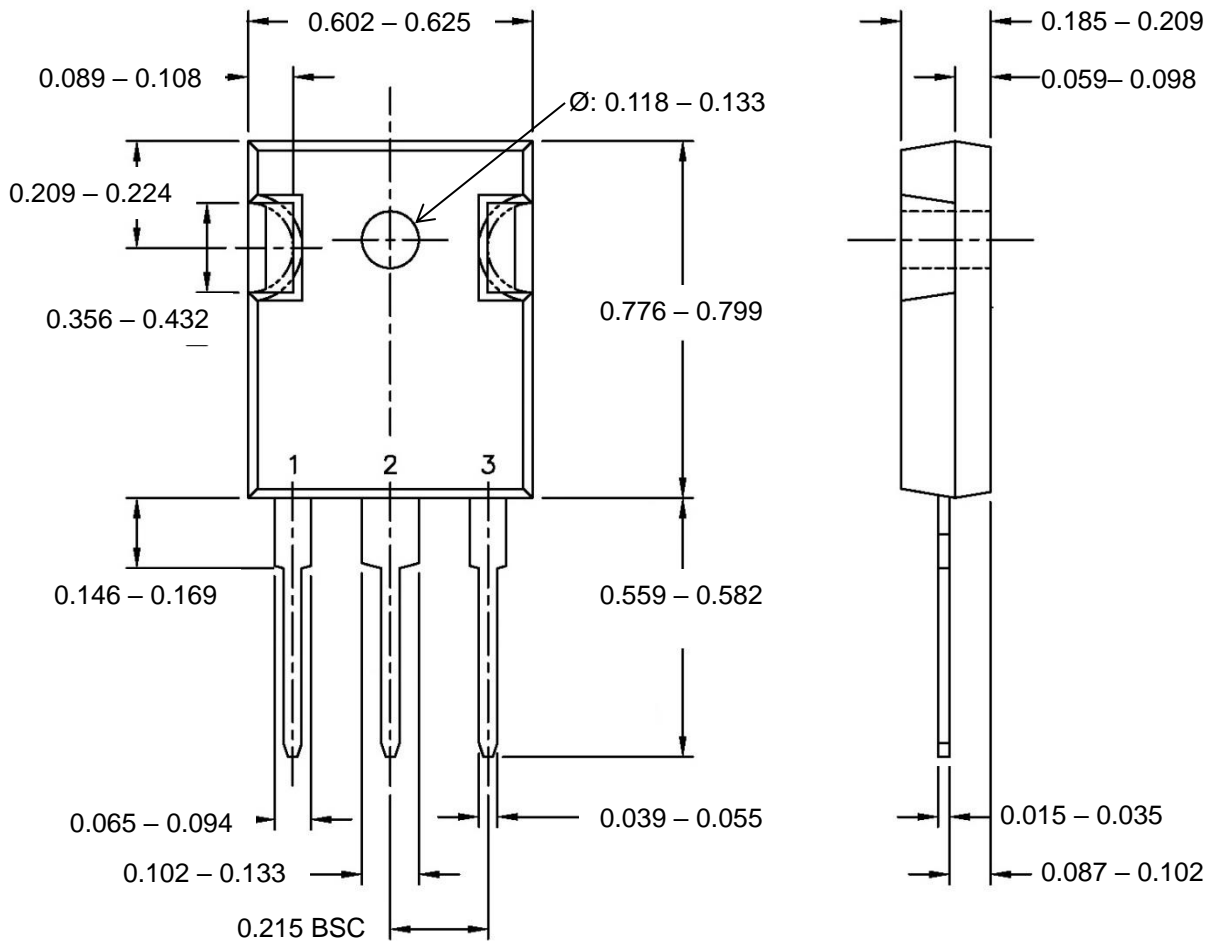
Note 3 Short Circuit < 1000 times, Short Circuit Interval: > 1s

## Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Statistic Characteristic						
Collector to Emitter Breakdown Voltage	V <sub>BR,CE</sub>	V <sub>GE</sub> =0V, I <sub>C</sub> =250μA	1200			V
Collector to Emitter Saturation Voltage	V <sub>CE,SAT</sub>	V <sub>GE</sub> =15V, I <sub>C</sub> =40A		1.85	2.2	V
Diode Forward Voltage	V <sub>F</sub>	V <sub>GE</sub> =0V I <sub>F</sub> =40A		2.3		V
Gate Threshold Voltage	V <sub>GE</sub>	I <sub>C</sub> =1mA, V <sub>CE</sub> =V <sub>GE</sub>	5.0	6.0	7.0	V
Collector Leakage Current	I <sub>CES</sub>	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V			0.1	mA
		V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V, T <sub>J</sub> =150°C			4	
Gate Leakage Current	I <sub>GES</sub>	V <sub>GE</sub> =20V, V <sub>CE</sub> =0V			250	nA
Transconductance	g <sub>FS</sub>	V <sub>CE</sub> =20V, I <sub>C</sub> =40A		20		S
Dynamic Characteristic						
Input Capacitance	C <sub>ISS</sub>	V <sub>CE</sub> =25V, V <sub>GE</sub> =0V, f=1MHz		2707		pF
Output Capacitance	C <sub>OSS</sub>			217		pF
Reverse Transfer Capacitance	C <sub>RES</sub>			102		pF
Gate Charge	Q <sub>G</sub>	V <sub>CC</sub> =600V, I <sub>C</sub> =40A, V <sub>GE</sub> =15V		150		nC
IGBT Switching Characteristic						
Turn ON Delay time	t <sub>D(ON)</sub>	V <sub>CC</sub> =600V, I <sub>C</sub> =40A, V <sub>GE</sub> =0/15V, R <sub>G</sub> =10Ω, inductive load		48		ns
Rise Time	t <sub>r</sub>			70		
Turn OFF delay time	t <sub>D(OFF)</sub>			266		
Fall Time	t <sub>f</sub>			160		
Turn ON Energy Loss	E <sub>ON</sub>			3.3		mJ
Turn OFF Energy Loss	E <sub>OFF</sub>			2.7		
Switching Energy Loss	E <sub>ts</sub>			6.0		
Diode Switching Characteristic						
Reverse Recovery Time	t <sub>rr</sub>	V <sub>R</sub> =600V, I <sub>F</sub> =20A, dI <sub>F</sub> /dt = 100A/μs		206		ns
Reverse Recovery Charge	Q <sub>rr</sub>			1.1		μC
Reverse Recovery Peak Current	I <sub>rrm</sub>			11.2		A

## Package Dimension – TO247

Unit: Inches



## Ordering Number

**GM G 40B120M TD3 I**

APM Gamma Micro	Product Category	Short Description	Package Type	Shipping Type
	Discrete IGBT	40: $I_C = 40A$ 120: $V_{CE} = 1200V$	TD3: 3L TO247	T: Tube

Note:

### Green products:

- ♦ Halogen free(Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight)